

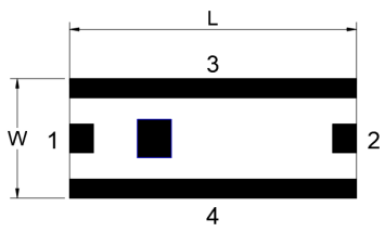
Features

- Multilayer monolithic construction yields high reliability
- Low insertion loss and small size SMD chip design
- Can simplify your complex tuning and circuit design
- LTCC process

Specifications

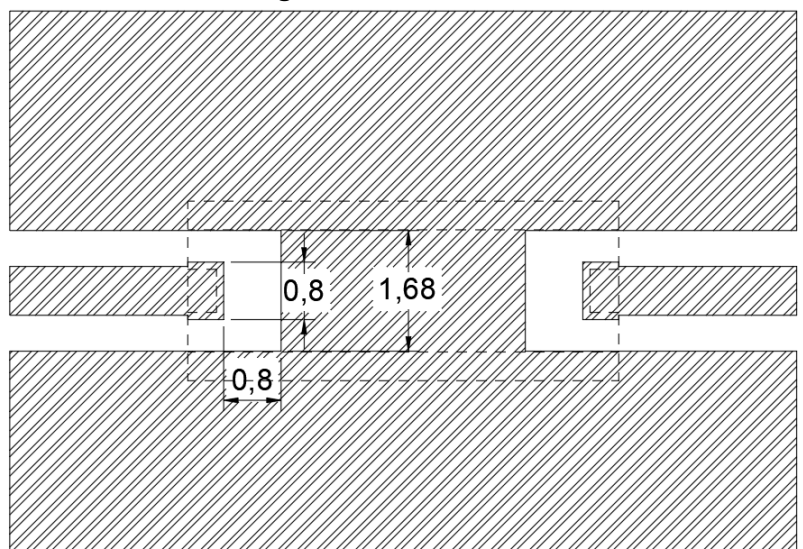
NO.	Parameter		SPEC
1	Frequency (MHz)		5850~6200
2	Insertion Loss (dB) @25℃		≤3.0
3	VSWR(In BW)		≤2.5
4	Attenuation(dB)	5300MHz	≥35
		6700MHz	≥20
5	In/Output Impedance (Ω)		50
6	Power		5W
Operating & Storage Condition (Component) Operation Temperature Range: -40℃ ~ +85℃ Storage Temperature Range: -40℃~ +85℃			
Storage Condition before Soldering (Included packaging material) Storage Temperature Range: +5 ~ +40 ℃ Humidity: 30 to 70% relative humidity			

Construction



PIN	Connection
1	Input Port
2	Output Port
3	GND
4	GND

Mounting Considerations



Unit: mm

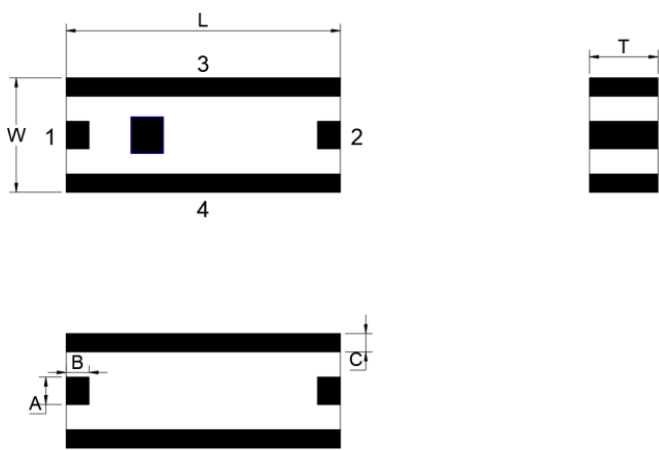
Yantel Corporation

Add: No.308-322,3F,Building 1,Juchuang Jingu Innovation Park,Wenyuan Road 35,Xili Street,Nanshan,Shenzhen,China

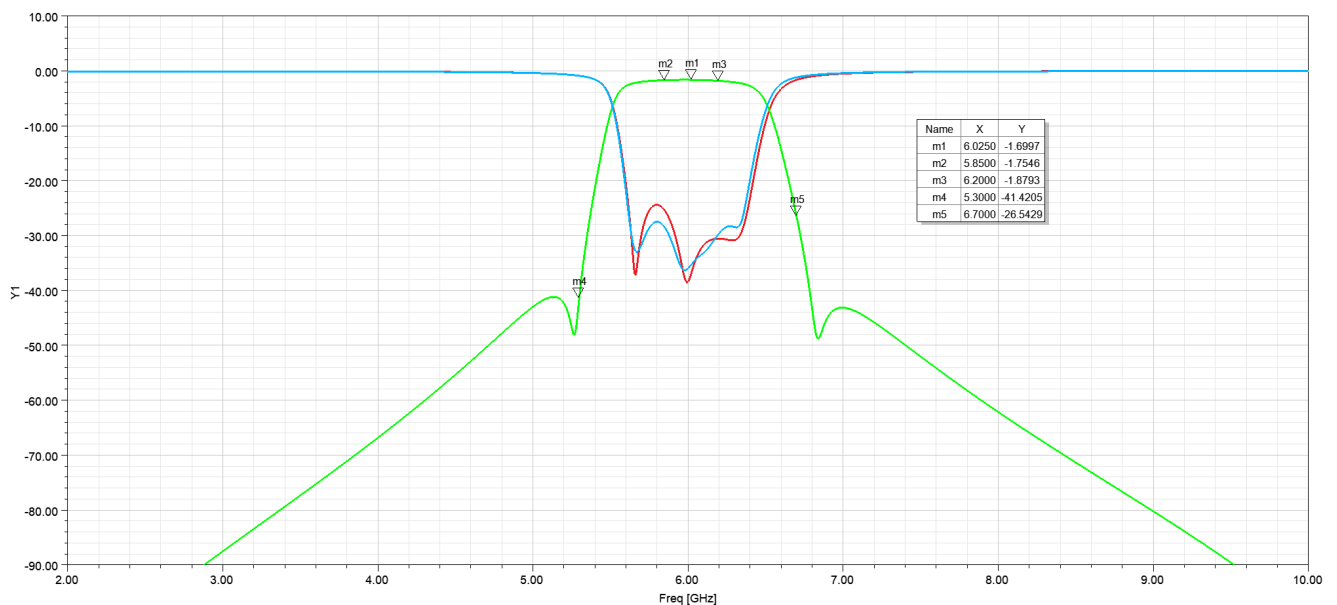
Tel: 86-755-8355-1886 Fax: 86-755-8355-2533

For detailed performance specs & shopping online see Yantel web site : www.yantel-corp.com

Dimensions

Figure	Symbol	Dimension (mm)
	L	6.00 ± 0.20
	W	2.50 ± 0.20
	T	2.00MAX
	A	0.60± 0.10
	B	0.40 ± 0.10
	C	0.40± 0.10

Typical Electrical Characteristics (T=25°C)



Solder Reflow Standard Conditioning



Storage Conditions

Temperature : +5 to +30 °C

Humidity : 20 to 70% RH

Term of storage : Within 12 months (After the delivery) *

Baking : Unnecessary

* After peeling off cover tape, do not keep exposing the products to the open air. For the products stored longer than 12 months, confirm their terminals and solderability before use.